

ON Semiconductor® FQD13N06L / FQU13N06L N-Channel QFET® MOSFET 60 V, 11 A, 115 mΩ

Description

This N-Channel enhancement mode power MOSFET is produced using ON Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

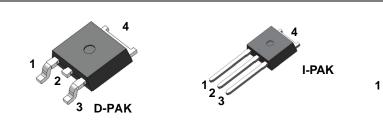
Features

- + 11 A, 60 V, ${\rm R}_{\rm DS(on)}$ = 115 m Ω (Max) @ V_{\rm GS} = 10 V, ${\rm I}_{\rm D}$ = 5.5 A
- Low Gate Charge (Typ. 4.8 nC)
- Low Crss (Typ. 17 pF)
- 100% Avalanche Tested
- Low Level Gate Drive Requirements Allowing Direct Operation form Logic Drivers

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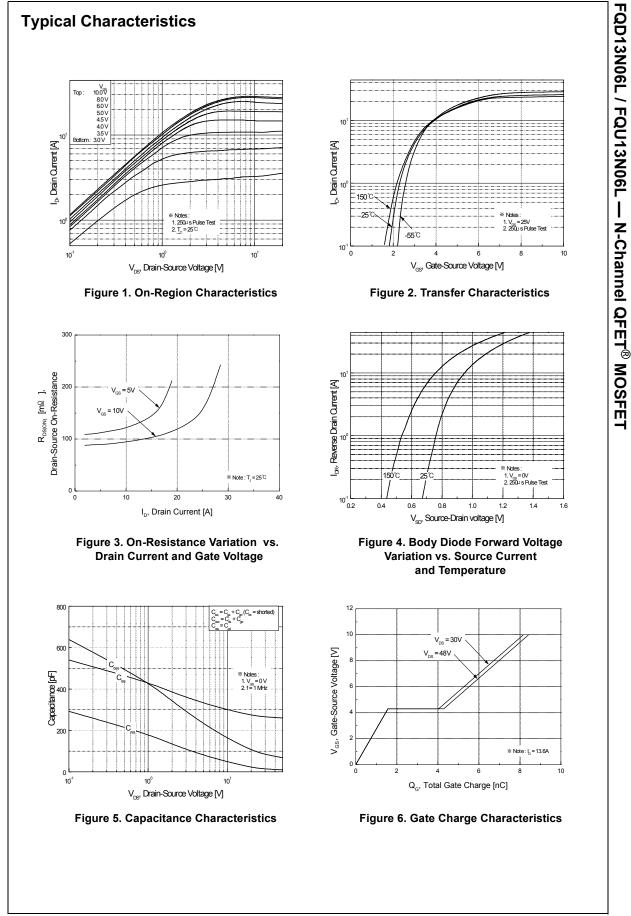
Symbol	Parameter	FQD13N06LTM / FQU13N06LTU FQU13N06LTU-WS	Unit V	
V _{DSS}	Drain-Source Voltage	60		
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$)		11	А
	- Continuous (T _C = 100°C)		7	А
I _{DM}	Drain Current - Pulsed	(Note 1)	44	А
V _{GSS}	Gate-Source Voltage		± 20	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	90	mJ
I _{AR}	Avalanche Current	(Note 1)	11	А
E _{AR}	Repetitive Avalanche Energy	(Note 1)	2.8	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	7.0	V/ns
P _D	Power Dissipation ($T_A = 25^{\circ}C$) *	2.5	W	
	Power Dissipation ($T_C = 25^{\circ}C$)	28	W	
	- Derate above 25°C	0.22	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case 5 or Seconds	300	°C	

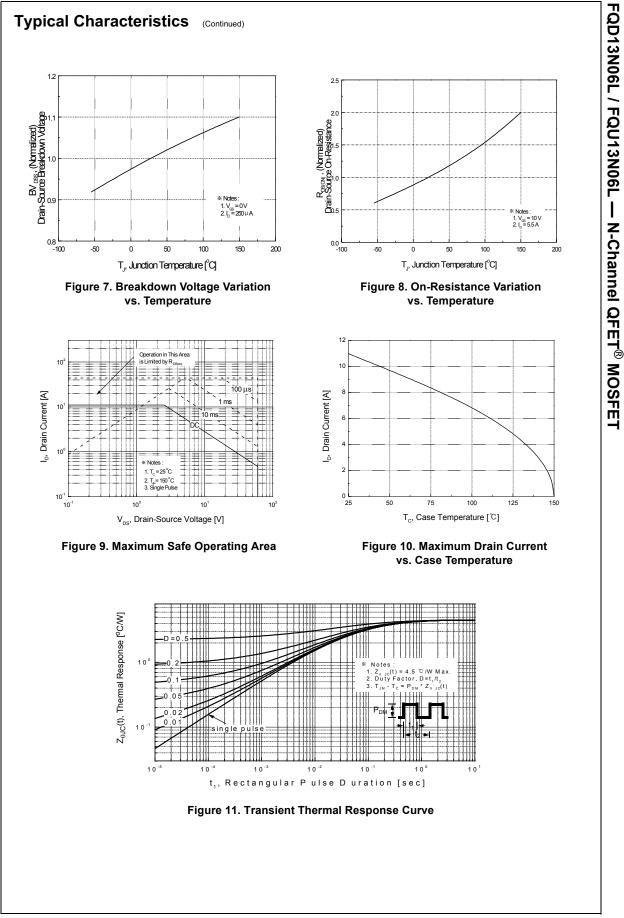
Thermal Characteristics

Symbol	Thermal Resistance, Junction to Case, Max. Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	FQD13N06LTM FQU13N06LTU FQU13N06LTU-WS	Unit
R_{\thetaJC}	Thermal Resistance, Junction to Case, Max.	2.5	
Р	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	110	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient (*1 in ² Pad of 2-oz Copper), Max.	50	

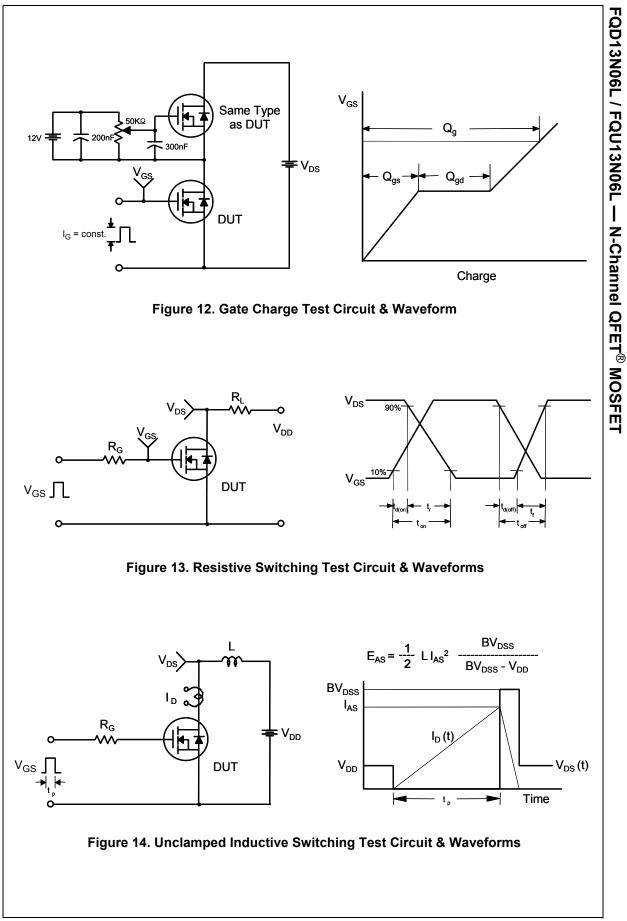
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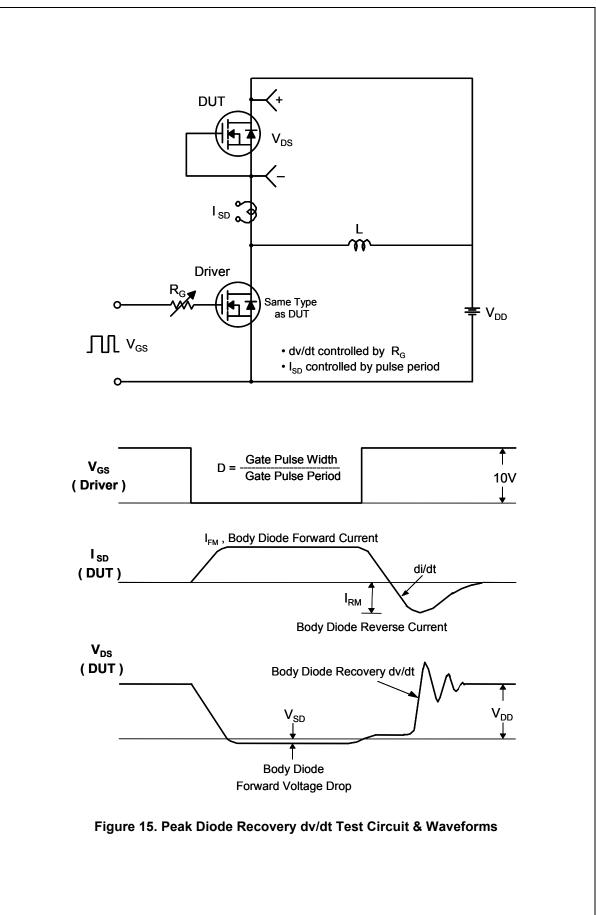
	N06LTM		Top Mark Pack		-	000		4.0		0500 1
FQU13		FQD13N06L		PAK Tape and Reel 330			16 mm		2500 units	
FQU13N06LTUFQU13N06LI-P.FQU13N06LTU-WSFQU13N06LSI-P.					Tube	N/		N/A		70 units
		AK Tube N/			A	N/A		75 units		
lectric	cal Chai	racteristics	Γ _c = 25°C un	less otherwis	se noted.					
Symbol		Parameter			Test Conditions		Min	Тур	Max	Unit
Off Cha	racteristi	cs								
3V _{DSS}	Drain-Source Breakdown Voltage		V _{GS} = 0 V, I _D = 250 μA			60			V	
ABV _{DSS}	Breakdown Voltage Temperature									
ΔT_{J}	Coefficient	•		$I_{\rm D} = 250$	0 μA, Referenced to	5 25°C		0.05		V/°C
DSS	Zoro Coto	Voltago Drain Curr	ont		V _{DS} = 60 V, V _{GS} = 0 V				1	μA
	Zero Gate Voltage Drain Current			V _{DS} = 48 V, T _C = 150°C					10	μA
GSSF	Gate-Body	Leakage Current,	Forward	V _{GS} = 2	20 V, V _{DS} = 0 V				100	nA
GSSR	Gate-Body	Leakage Current,	Reverse	V _{GS} = -	20 V, V _{DS} = 0 V				-100	nA
)n Cha	racteristi	<u> </u>								
/ _{GS(th)}		shold Voltage		V _{DS} = \	/ _{GS} , I _D = 250 μA		1.0		2.5	V
R _{DS(on)}	Static Drain			-	10 V, I _D = 5.5 A			0.092	0.115	
D3(01)	On-Resista			00	$V, I_D = 5.5 A$			0.115	0.145	
FS	Forward Tr	ansconductance		V _{DS} = 2	25 V, I _D = 5.5 A			6		S
_							1	1	1	4
-	c Charac						1	070	050	-
Ciss	Input Capa				25 V, V _{GS} = 0 V,			270	350	pF
C _{oss}	Output Cap			f = 1.0 I	MHz			95	125	pF
C _{rss}	Reverse II	ansfer Capacitance	e					17	23	pF
Switchi	ng Chara	cteristics								
d(on)	Turn-On D	elay Time		Van = 3	30 V, I _D = 6.8 A,			8	25	ns
r	Turn-On Ri	ise Time		$R_G = 25$	-			90	190	ns
d(off)	Turn-Off D	elay Time		G				20	50	ns
f	Turn-Off Fa	all Time		1		(Note 4)		40	90	ns
ל ^g	Total Gate	Charge		V _{DS} = 4	18 V, I _D = 13.6 A,			4.8	6.4	nC
ຊ _{gs}	Gate-Sour	ce Charge		V _{GS} = 5	-			1.6		nC
ວ _{gd}	Gate-Drain	Charge				(Note 4)		2.7		nC
							1		1	- 4
		ode Characteri					1	1		
S		Continuous Drain-S							11	A
SM		Pulsed Drain-Sourc							44	A
/ _{SD}		ce Diode Forward	Voltage) V, I _S = 11 A				1.5	V
rr		ecovery Time		00) V, I _S = 13.6 A,			45		ns
2 ⁿ	Reverse R	ecovery Charge		al _F / at	= 100 A/μs			45		nC
L = 870 µH, I _{SD} ≤ 13.6 A	l _{AS} = 11 A, V _{DD} , di/dt ≤ 300 A/μ	th limited by maximum ju = 25 V, $R_G = 25 \Omega$, startir s, $V_{DD} \le BV_{DSS}$, starting T sperating temperature.	ng T _J = 25°C.							



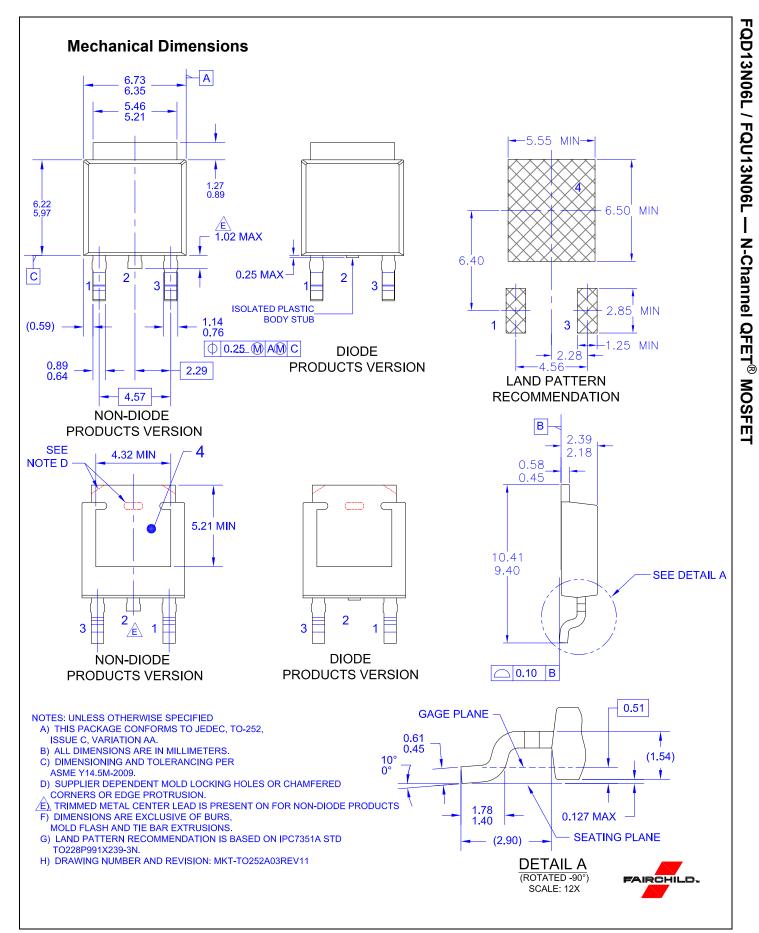


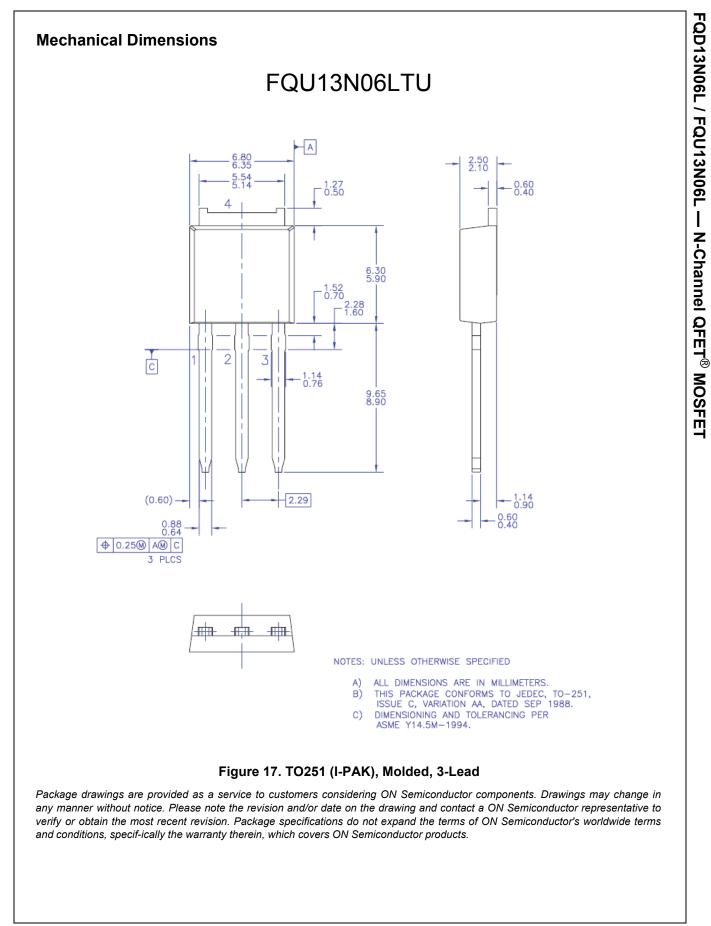
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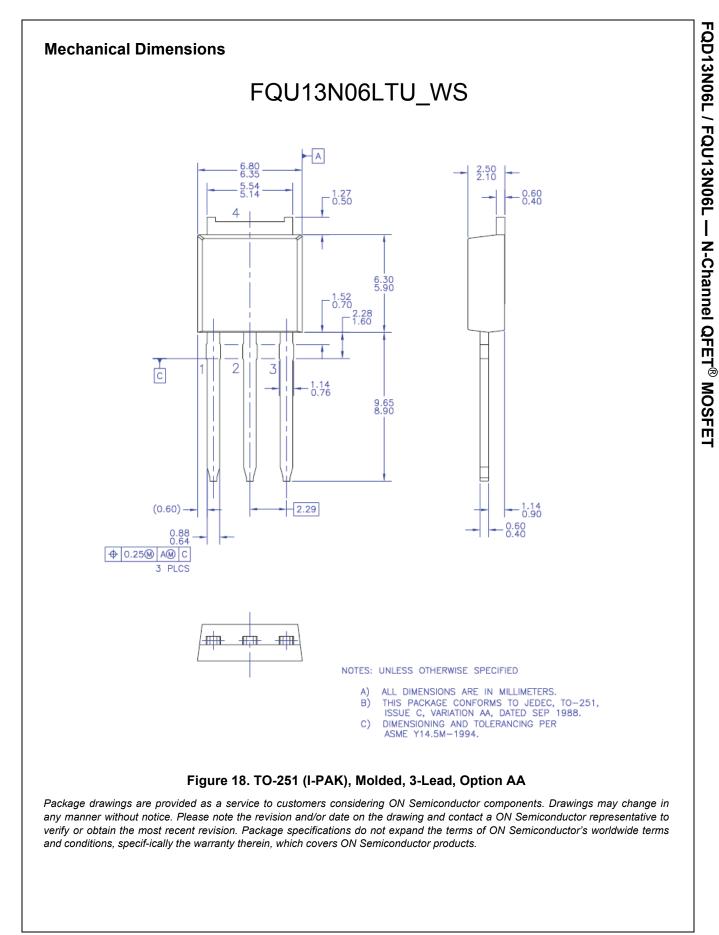




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